

Features

- 3mm Through hole, 5.08mm lens height
- High Brightness
- Water Clear lens
- InGaN / AllnGaP Technology
- Special packaging available upon request
- · High reliability

Applications

- Consumer Electronics
- Variable Message Signs (VMS)
- Automobile After Market
- Industrial Equipment
- Advertising Signs

Description

The INL-3AX30 is high brightness 30 degrees through-hole lamp. It is a 3mm epoxy type LED which can be used in various applications.

Package Dimensions in mm

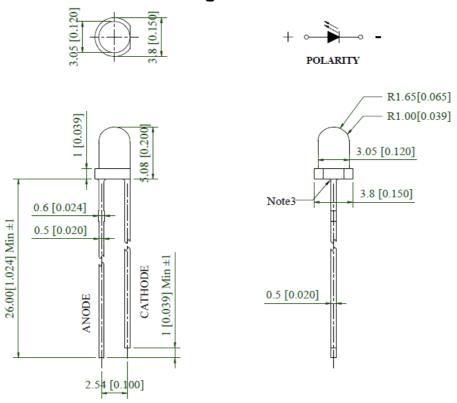


Figure 1. INL-3AX30 Package Dimensions



Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	Top (°C)	Tst (°C)
INL-3AYG30	Yellow Green						
INL3AY30	Yellow	65	0.5	400			
INL3AA30	Amber	65 25	100				
INL3AR30	Red				5	-40°C~+85°C	-40°C~+100°C
INL3AB30	Blue						
INL3AG30	Green	95	25	100			
INL3AW30	White						

Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width



Electrical Characteristics T_A = 25℃ (Note 1)

	Emission		VF	(V)		λ(nm)		Viewing Angle	l*v(ı	mcd)
Product	Emission Color	I _F (mA)	min	max	λ_{D}	λР	Δλ	2 <i>H</i> 1/2	min	typ.
INL-3AYG30	Yellow Green	20	1.6	2.6	573	575	20	30	160	270
INL3AY30	Yellow	20	1.6	2.6	592	590	15	30	270	460
INL3AA30	Amber	20	1.6	2.6	610	605	35	30	270	460
INL3AR30	Red	20	1.6	2.6	632	624	20	30	460	780
INL3AB30	Blue	20	2.6	3.8	470	468	25	30	3800	5000
INL3AG30	Green	20	2.8	3.8	525	520	35	30	11000	18000
INL3AW30	White	20	2.8	3.8		X = 0.28 Y = 0.28		30	5000	8500

Notes

1. Performance guaranteed only under conditions listed in above tables.

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection

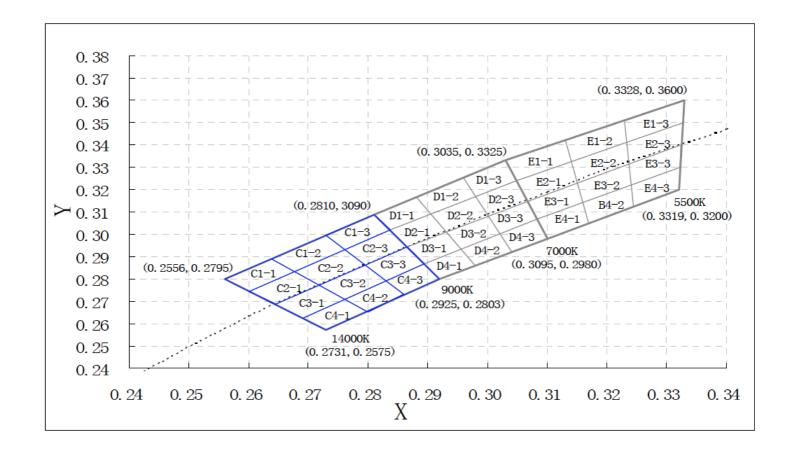


The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).



Chromaticity Bin (For White Only)



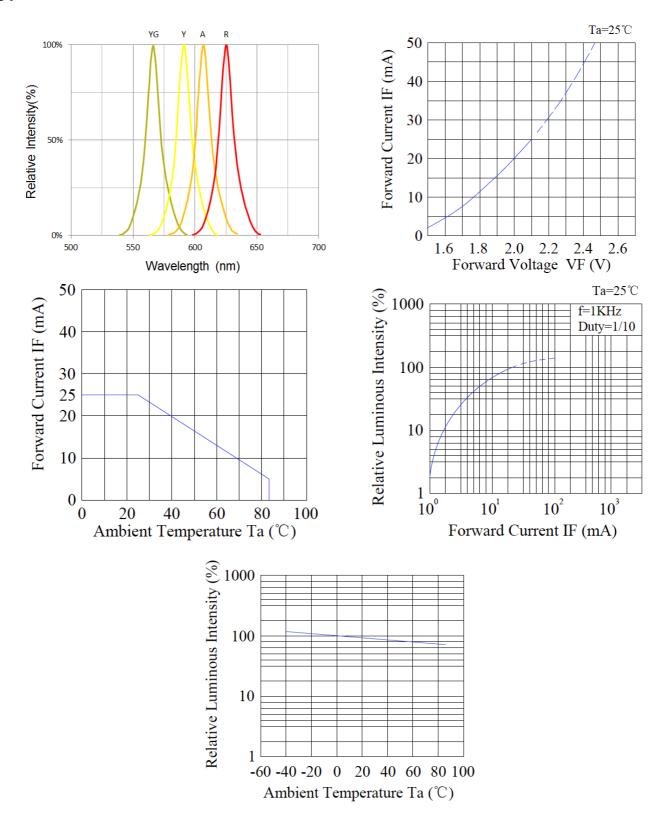




				_				
Bin Code	Left x	Left y	Тор х	Тор у	Right x	Right y	Bottom x	Bottom y
C1-1	0.256	0.28	0.264	0.289	0.268	0.283	0.26	0.274
C2-1	0.26	0.274	0.268	0.283	0.272	0.277	0.264	0.269
C3-1	0.264	0.269	0.272	0.277	0.276	0.271	0.269	0.263
C4-1	0.269	0.263	0.276	0.271	0.28	0.265	0.273	0.257
C1-2	0.264	0.289	0.273	0.299	0.276	0.293	0.268	0.283
C2-2	0.268	0.283	0.276	0.293	0.279	0.286	0.272	0.277
C3-2	0.272	0.277	0.279	0.286	0.283	0.279	0.276	0.271
C4-2	0.276	0.271	0.283	0.279	0.286	0.273	0.28	0.265
C1-3	0.273	0.299	0.281	0.309	0.284	0.302	0.276	0.293
C2-3	0.276	0.293	0.284	0.302	0.287	0.295	0.279	0.286
C3-3	0.279	0.286	0.287	0.295	0.29	0.287	0.283	0.279
C4-3	0.283	0.279	0.29	0.287	0.292	0.28	0.286	0.273
D1-1	0.281	0.309	0.288	0.317	0.291	0.309	0.284	0.302
D2-1	0.284	0.302	0.291	0.309	0.293	0.302	0.287	0.295
D3-1	0.287	0.295	0.293	0.302	0.296	0.294	0.29	0.287
D4-1	0.29	0.287	0.296	0.294	0.298	0.286	0.292	0.28
D1-2	0.288	0.317	0.296	0.325	0.298	0.317	0.291	0.309
D2-2	0.291	0.309	0.298	0.317	0.3	0.308	0.293	0.302
D3-2	0.293	0.302	0.3	0.308	0.302	0.3	0.296	0.294
D4-2	0.296	0.294	0.302	0.3	0.304	0.292	0.298	0.286
D1-3	0.296	0.325	0.303	0.333	0.305	0.324	0.298	0.317
D2-3	0.298	0.317	0.305	0.324	0.307	0.315	0.3	0.308
D3-3	0.3	0.308	0.307	0.315	0.308	0.307	0.302	0.3
D4-3	0.302	0.3	0.308	0.307	0.31	0.298	0.304	0.292
E1-1	0.303	0.333	0.313	0.342	0.314	0.333	0.305	0.324
E2-1	0.305	0.324	0.314	0.333	0.315	0.324	0.307	0.315
E3-1	0.307	0.315	0.315	0.324	0.316	0.314	0.308	0.307
E4-1	0.308	0.307	0.316	0.314	0.317	0.305	0.31	0.298
E1-2	0.313	0.342	0.323	0.351	0.323	0.341	0.314	0.333
E2-2	0.314	0.333	0.323	0.341	0.324	0.332	0.315	0.324
E3-2	0.315	0.324	0.324	0.332	0.324	0.322	0.316	0.314
E4-2	0.316	0.314	0.324	0.322	0.324	0.313	0.317	0.305
E1-3	0.323	0.351	0.333	0.36	0.333	0.35	0.323	0.341
E2-3	0.324	0.332	0.333	0.35	0.332	0.34	0.324	0.331
E3-3	0.324	0.332	0.332	0.34	0.332	0.33	0.324	0.322
E4-3	0.324	0.322	0.332	0.33	0.332	0.32	0.324	0.313

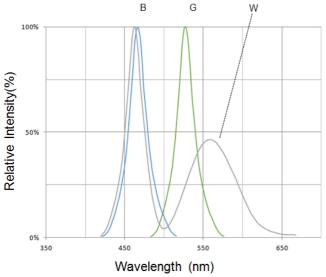


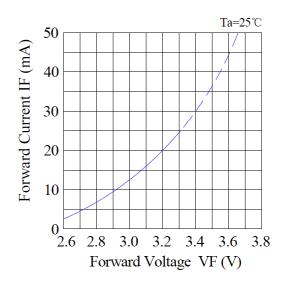
Typical Characteristic Curves - YG, Y, A, R

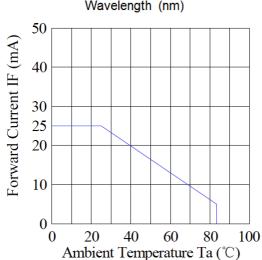


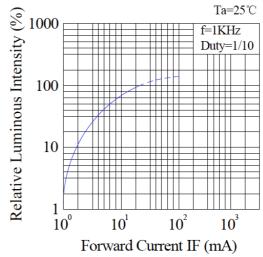


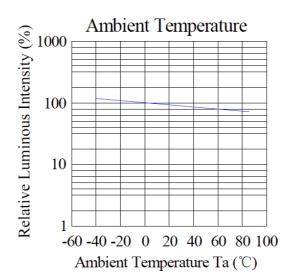
Typical Characteristic Curves - B, G, W







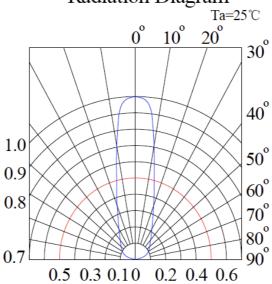






Typical Characteristic Curves – Radiation Pattern



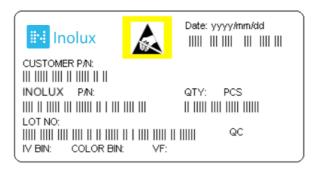


Ordering Information

Product	Emission Color	Technology	Test Current I _F (mA)	Luminous Intensity I _V (mcd) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number
INL-3AYG30	Yellow Green	AlinGaP	20	270	2.0	INL-3AYG30
INL3AY30	Yellow	AlinGaP	20	460	2.0	INL3AY30
INL3AA30	Amber	AlinGaP	20	460	2.0	INL3AA30
INL3AR30	Red	AlinGaP	20	780	2.0	INL3AR30
INL3AB30	Blue	InGaN	20	5000	3.2	INL3AB30
INL3AG30	Green	InGaN	20	18000	3.2	INL3AG30
INL3AW30	White	InGaN	20	8500	3.1	INL3AW30



Label Specifications



Inolux P/N:

ı	N	L	-	3	А		Υ	3	0	-	Х	Х	Х	Х
			Material			Lens	Color	View Angle			Customized Stamp-off			
	Inolux ough I Lamp	Hole		with f	3mm lange, neight	(Blank) = Clear Lens	R=636nm A=609nm Y=593nm YG=574nm G=530nm B=468nm W=White	30 = 3	0 deg.					

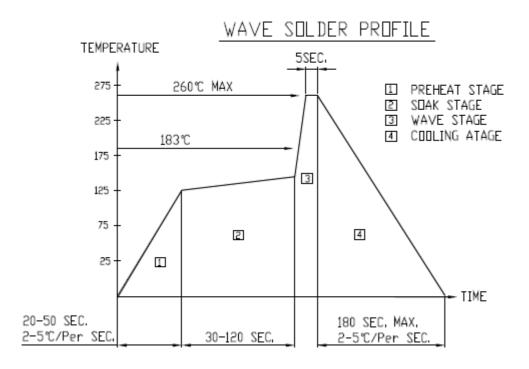
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	, 2018,)	Month	Date	Serial	
Tracker		real (2017	, 2016,)	WOTH	Date	Serial	



Soldering

Recommended soldering conditions:



Soldering Iron

Basic Spec is Max 3 sec. @ 300°C. Lamps without stopper must leave a min. of 3mm clearance from base of the lens to the soldering point.

Rework

Caution is advised when rework is performed. Rework should be completed within 4 second under 245°C using a double-headed soldering iron.



Reliability

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions		
	7-0117-017-0-0		4 \ D 1		
D 1111	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs		
Precondition	monitoring tests according		2.) Moisture storage at 85°C/ 60% R.H. for		
	to JEDEC Level 2		168hrs		
	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155°C/ 24hrs		
Solderability		And CNS-5068	Tinning speed: 2.5+0.5cm/s		
			Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s		
		CNS-5067	Dipping soldering terminal only		
Resistance to			Soldering bath temperature		
soldering heat			A: 260+/-5°C; 10+/-1s		
			B: 350+/-10°C; 3+/-0.5s		
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs		
Operating life test			85°C/ 60%R.H. for 168hrs		
			2.) Tamb25°C; IF=20mA; duration 1000hrs		
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C		
high temperature			Humidity: 85% R.H., IF=5mA		
bias			Duration: 1000hrs		
	1Q/ 1/ 20	IN specs.	Tamb: 55°C		
High temperature			IF=20mA		
bias			Duration: 1000hrs		
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty		
Pulse life test			cycle=0.125 (tp=125 μ s,T=1sec)		
l disc inc test			Duration 500hrs)		
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C		
	1 47 17 107 0	IEC 68-2-14, Nb	15min		
Temperature		120 00-2-14, 140	Thermal steady within 5 min		
cycle			300 cycles		
Lliab burniditu	1Q/ 1/ 40/ 0	CNS-6117	2 chamber/ Air-to-air type 60+3°C		
High humidity	10/ 1/40/0	CN3-011/			
storage test	10/1/10/0	ONO FEA	90+5/-10% R.H. for 500hrs		
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs		
storage test		2012 2445			
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs		
storage test					



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	07-10-2017
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